



NF-02-PE Specification

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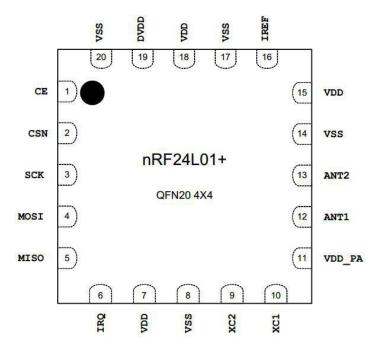


Overview 0

NF-02-PE is a 100mW power wireless transceiver integrated 2.4G module, embedded nRF24L01+ RF chip; DIP-8 packages that can be quickly docked to existing products; -altitude medium rate (up to 2 Mbps), using SPI interface, high stability, high performance-price ratio. NF-02-PE suitable for a variety of Internet of things occasions, widely used in wireless mouse, wireless remote control, somatosensory devices, active RFID, NFC, low-power ad hoc wireless sensor nodes are Internet of things applications Ideal product.

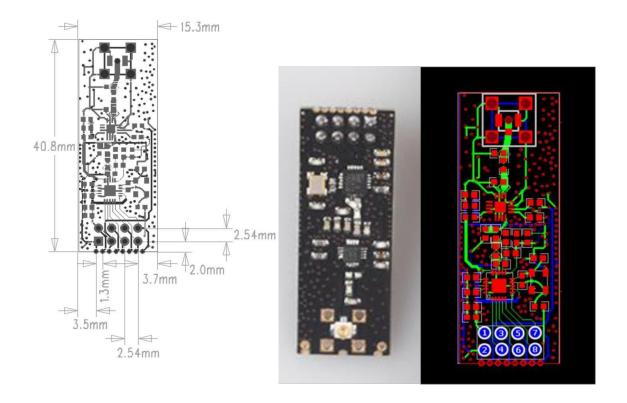
Appearance dimensions

Chip image





NF-01-N Module image



| No. | Parameter Name | Parameters | Note | | |
|----------------------------------|--|---|---|--|--|
| 01 | RF chip | nRF24L01+ | Nordic | | |
| | Power amplifier chip | RFX2401C | Power amplification, increase gain | | |
| 02 | module size | 40.8*15.3 unit:mm | \pm 0.2mm | | |
| 03 | Modulation mode | GFSK modulation mode | Gaussian frequency shift keying | | |
| 04 | Package | DIP-8 | | | |
| 05 | Interface | Adopt four-wire SPI interface | SPI port Maximum rate not | | |
| | | | greater than 10 M | | |
| 06 | Transmission power | Maximum is 20 dBm | Others refer to chip datasheet | | |
| 07 | RSSI support | Support | Signa Ireceived strength detection | | |
| 08 | Operating frequency | 2.4GHz ~ 2.525GHz | Adjustable,1MHz | | |
| 09 | Voltage range | 1.9 ~ 3.6V, typical value 3.3 | Excessive voltage would damage the module | | |
| 10 | Data rate | support 2Mbps/1Mbps/250Kbps | More details refer to chip datasheet | | |
| 11 | Channel | 126 RF Channel | Each channel is separated 1MHz | | |
| 12 | Test range | 100m | Sunny, no barrier , maximum transmit power | | |
| 13 | Receiving sensitivity | -94dBm@250Kbps | other details refer to chip datasheet | | |
| 14 | Antenna interface | On-board pcb antenna | | | |
| 15 | Emission length | Single packet 1~32 byte | 3class FIFO | | |
| 16 | Received length | Single packet 1~32 byte | 3class FIFO | | |
| 09 10 11 12 13 14 | Voltage range Data rate Channel Test range Receiving sensitivity Antenna interface Emission length | 1.9~3.6V, typical value 3.3 support 2Mbps/1Mbps/250Kbps 126 RF Channel 100m -94dBm@250Kbps On-board pcb antenna Single packet 1~32 byte | Excessive voltage would damage the modern More details refer to chip datasheet Each channel is separated 1MHz Sunny, no barrier, maximum transmit pother details refer to chip datasheet 3class FIFO | | |

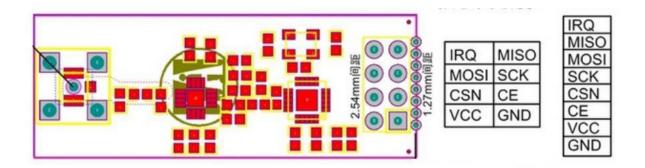


| 17 | Operating temperature -20 $^{\circ}$ + 70 $^{\circ}$ C excessive temperature would damage the module | | | |
|----|---|-----------------|---------------------------------------|--|
| 18 | Storage temperature -40 $^{\sim}$ $+125$ $^{\circ}\mathrm{C}$ excessive temperature would damage the module | | | |
| 19 | Standby current | 26μΑ | other details are chip manual | |
| 20 | Receive current | 13.5 mA (2Mbps) | for other details see Chip Manual | |
| 21 | Emission current | 11.5mA (0dBm) | for other details see the chip manual | |

| D • | 1 | C· | • | , • | |
|------|---|-------------------|-----|--------------|-----|
| Pin | d | AT1 | ١1 | 11 | on |
| 1 11 | u | $C \perp \perp 1$ | 1 Т | $\cup \perp$ | OII |

| Name | Direction | Purpose |
|------|-----------|--|
| VCC | - | power supply must be between 1.9~3.6 V |
| GND | - | ground wire, connected to power reference ground |
| CSN | input | module chip select pin for starting a SPI communication |
| CE | input | module enables control foot, CE low level is in standby mode |
| MOSI | input | module SPI data input pin |
| SCK | input | module SPI bus clock |
| IRQ | output | module interrupt signal output, low level effective |
| MISO | output | module SPI data output pin |

Pin definition image



Noted

- 01. Electrostatic---- high frequency analog devices are electrostatic sensitive, please avoid contact with electronic components on the module as far as possible
- 02. Power----supply to ensure that the power supply must have a small ripple, to avoid a large run out of the power supply voltage value, it is recommended to use π type. Filter (Ceramic Capacitor/Tam Capacitor Inductor)
- 03. Ground wire----module ground wire using single point grounding mode, recommended to use 0 oh resistance, or 0 mH inductance, other parts of the electricity refer separated

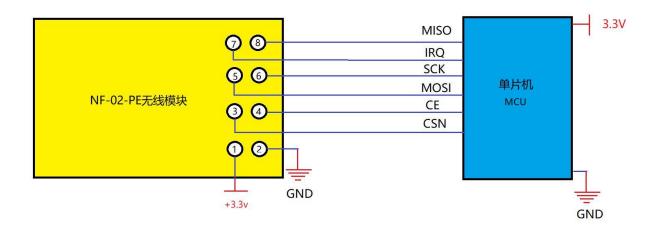


04. Antenna-----If the antenna is covered by a metal shell, some components will affect the performance of the antenna, such as relays. Make sure the antenna is exposed, preferably vertically up

05. Interference-----If there are other wireless modules in the same product, it is necessary to plan the frequency reasonably and adopt shielding measures,

06. Crystal oscillator----- Reduce the effect of harmonic interference and intermodulation interference. If there is a crystal oscillator near the circuit board of the module, please increase the straight line distance between the crystal oscillator and the module.

Typical circuit



schematic diagram of the connection between MCU and NF-02-PE

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